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285

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CONTENTS



A Survey on LDPC Decoding Techniques	1-7
<i>Varsha Vimal Sood, H. P. Sinha and Alka Kalra</i>	
A New Approach for Placement of Capacitor in Radial Distribution System for Improvement of Voltage Profile and Reduction of Power Loss	9-13
<i>Nasim Ali Khan, Saradindu Ghosh and Shakti Prasad Ghoshal</i>	
Microgrid as an Energy Storage System	15-21
<i>Nawaraj Sharma, Bhola Jha and Shankar Acharya</i>	
The Next Challenge for Next Generation Mobile Communication and Computing in Terms of Wire, Cable and Wireless: Mobile System Case Study I	23-29
<i>N. T. Markad, R. D. Kanphade and D. G. Wakade</i>	
Reduction of Coupling between Microstrip Array Antennas using Electromagnetic Band Gap structure	31-35
<i>K. P. Saranya, S. Sangeetha, A. Glory and J. Vidhiya</i>	
Application of Brushless Dc Drives in Blow Molding	37-42
<i>R. Devasaran, Pankaj Rai, Arvind Kumar Singh and Satyendra Kumar</i>	